# 3.3V / 5V ECL Differential Receiver/Driver with Variable Output Swing

# Description

The MC100EP16VS is a differential receiver with variable output amplitude. The device is functionally equivalent to the 100EP16 with an input pin that controls the amplitude of the outputs.

The  $V_{CTRL}$  input pin controls the output amplitude of the EP16VS and is referenced to  $V_{CC}$ . (See Figure 4.) The operational range of the  $V_{CTRL}$  input is from  $\leq V_{BB}$  (max output amplitude) to  $V_{CC}$  (min output amplitude). (See Figure 3.) A variable resistor between the  $V_{CC}$  and  $V_{BB}$  pins, with the wiper driving  $V_{CTRL}$ , can control the output amplitude. Typical application circuits and a  $V_{CTRL}$  Voltage vs. Output Amplitude graph are described in this data sheet. When left open, the  $V_{CTRL}$  pin will be internally pulled down to  $V_{EE}$  and operate as a standard EP16, with 100% output amplitude.

The  $V_{BB}$  pin, an internally generated voltage supply, is available to this device only. For single–ended input conditions, the unused differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{CC}$  via a 0.01  $\mu F$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  should be left open.

### **Features**

- 220 ps Propagation Delay
- Maximum Frequency > 4 GHz Typical (See Graph)
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range: V<sub>CC</sub> = 3.0 V to 5.5 V with V<sub>EE</sub> = 0 V
- NECL Mode Operating Range: V<sub>CC</sub> = 0 V with V<sub>EE</sub> = -3.0 V to -5.5 V
- Open Input Default State
- Q Output Will Default LOW with Inputs Open or at V<sub>EE</sub>
- Pb-Free Packages are Available



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## MARKING DIAGRAMS\*



SOIC-8 D SUFFIX CASE 751





TSSOP-8 DT SUFFIX CASE 948R





DFN8 MN SUFFIX CASE 506AA



A = Assembly Location

= Wafer Lot

Y = Year W = Work Week

M = Date Code

■ = Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

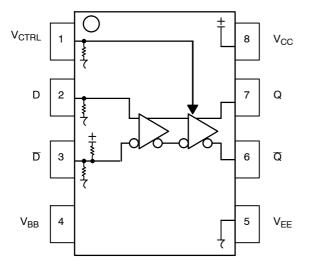


Figure 1. 8-Lead Pinout (Top View) and Logic Diagram

### **Table 1. PIN DESCRIPTION**

PIN	FUNCTION	
D*, <del>D</del> **	ECL Data Inputs	2, 3
Q, Q	ECL Data Outputs	6, 7
V <sub>CTRL</sub> *	Output Swing Control	1
V <sub>BB</sub>	Reference Voltage Output	4
V <sub>CC</sub>	Positive Supply	8
V <sub>EE</sub>	Negative Supply	5
NC	No Connect	
EP	(DFN8 only) Thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open.	-

- \* Pins will default LOW when left open.
- \*\* Pins will default to  $V_{\mbox{\footnotesize CC}}/2$  when left open.

**Table 2. ATTRIBUTES** 

Charact	Va	lue		
Internal Input Pulldown Resistor	75 kΩ			
Internal Input Pullup Resistor		37.5	5 kΩ	
ESD Protection	> 4 > 20 > 2			
Moisture Sensitivity, Indefinite T	ime Out of Drypack (Note 1)	Pb Pkg	Pb-Free Pkg	
	SOIC-8 TSSOP-8 DFN8	Level 1 Level 1 Level 1	Level 1 Level 3 Level 1	
Flammability Rating	UL 94 V-0	@ 0.125 in		
Transistor Count	140 D	evices		
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test				

<sup>1.</sup> For additional information, see Application Note AND8003/D.

**Table 3. MAXIMUM RATINGS** 

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
$V_{CC}$	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		6	V
V <sub>EE</sub>	NECL Mode Power Supply	V <sub>CC</sub> = 0 V		-6	V
V <sub>I</sub>	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	$\begin{aligned} &V_I \leq V_{CC} \\ &V_I \geq V_{EE} \end{aligned}$	6 -6	V V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
I <sub>BB</sub>	V <sub>BB</sub> Sink/Source			± 0.5	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	8 SOIC 8 SOIC	190 130	°C/W °C/W
θЈС	Thermal Resistance (Junction-to-Case)	Standard Board	8 SOIC	41 to 44	°C/W
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	8 TSSOP 8 TSSOP	185 140	°C/W
θЈС	Thermal Resistance (Junction-to-Case)	Standard Board	8 TSSOP	41 to 44 ± 5%	°C/W
$\theta_{\sf JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	DFN8 DFN8	129 84	°C/W °C/W
T <sub>sol</sub>	Wave Solder Pb Pb-Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C
θЈС	Thermal Resistance (Junction-to-Case)	(Note 2)	DFN8	35 to 40	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

2. JEDEC standard multilayer board – 2S2P (2 signal, 2 power)

Table 4. DC CHARACTERISTICS, PECL  $V_{CC} = 3.3 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$  (Note 3)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	30	36	42	31	38	44	32	40	48	mA
V <sub>OH</sub>	Output HIGH Voltage (Max Swing) (Note 4) $V_{CC} \ge V_{CTRL} \ge V_{EE}$	2155		2405	2155		2405	2155		2405	mV
V <sub>OL</sub>	Output LOW Voltage (Max Swing) (Note 4) V <sub>CTRL</sub> ≤ V <sub>BB</sub>	1355	1490	1605	1355	1520	1605	1355	1520	1605	mV
	VCC ≥ V <sub>CTRL</sub> > V <sub>BB</sub>		See Fig.2			See Fig.2			See Fig.2		
	V <sub>CTRL</sub> = V <sub>CC</sub> (Min Swing)	2105	2230	2355	2095	2220	2345	2065	2190	2315	
V <sub>IH</sub>	D, D Input HIGH Voltage (Single-Ended)	2075		2420	2075		2420	2075		2420	mV
V <sub>IL</sub>	D, D Input LOW Voltage (Single-Ended)	1355		1675	1355		1675	1355		1675	mV
$V_{BB}$	Output Voltage Reference	1805	1905	2005	1805	1905	2005	1805	1905	2005	mV
V <sub>CTRL</sub>	Input Voltage (V <sub>CTRL</sub> )	V <sub>EE</sub>		V <sub>CC</sub>	V <sub>EE</sub>		$V_{CC}$	V <sub>EE</sub>		$V_{CC}$	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 5)	2.0		2.9	2.0		2.9	2.0		2.9	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.3 V to -2.2 V.
   All loading with 50 Ω to V<sub>CC</sub> 2.0 V. V<sub>OH</sub> does not change with V<sub>CTRL</sub>. V<sub>OL</sub> changes with V<sub>CTRL</sub>. V<sub>CTRL</sub> is referenced to V<sub>CC</sub>.
   V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential

Table 5. DC CHARACTERISTICS, PECL  $V_{CC} = 5.0 \text{ V}$ ,  $V_{EE} = 0 \text{ V}$  (Note 6)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	30	36	42	31	38	44	32	40	48	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 7) V <sub>CC</sub> > V <sub>CTRL</sub> > V <sub>EE</sub>	3855	3980	4105	3855	3980	4105	3855	3980	4105	mV
V <sub>OL</sub>	Output LOW Voltage (Max Swing) (Note 7) V <sub>CTRL</sub> ≤ V <sub>BB</sub>	3055	3190	3305	3055	3220	3305	3055	3220	3305	mV
	VCC ≥ V <sub>CTRL</sub> > V <sub>BB</sub>		See Fig.2			See Fig.2			See Fig.2		
	V <sub>CTRL</sub> = V <sub>CC</sub> (Min Swing)	3805	3930	4055	3795	3920	4045	3765	3890	4015	
V <sub>IH</sub>	D, D Input HIGH Voltage (Single-Ended)	3775		4120	3775		4120	3775		4120	mV
V <sub>IL</sub>	D, D Input LOW Voltage (Single-Ended)	3055		3375	3055		3375	3055		3375	mV
V <sub>CTRL</sub>	Input Voltage (V <sub>CTRL</sub> )	V <sub>EE</sub>		$V_{CC}$	V <sub>EE</sub>		$V_{CC}$	V <sub>EE</sub>		$V_{CC}$	mV
$V_{BB}$	Output Voltage Reference	3505	3605	3705	3505	3605	3705	3505	3605	3705	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 8)	2.0		4.6	2.0		4.6	2.0		4.6	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current D D	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 6. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +2.0 V to -0.5 V.
   7. All loading with 50 Ω to V<sub>CC</sub> 2.0 V. V<sub>OH</sub> does not change with V<sub>CTRL</sub>. V<sub>OL</sub> changes with V<sub>CTRL</sub>. V<sub>CTRL</sub> is referenced to V<sub>CC</sub>.
   8. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input triangle.

Table 6. DC CHARACTERISTICS, NECL  $V_{CC} = 0 \text{ V}$ ;  $V_{EE} = -5.5 \text{ V}$  to -3.0 V (Note 9)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	30	36	42	31	38	44	32	40	48	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 10) V <sub>CC</sub> > V <sub>CTRL</sub> > V <sub>EE</sub>	-1145	-1020	-895	-1145	-1020	-895	-1145	-1020	-895	mV
V <sub>OL</sub>		-1945	-1810	-1695	-1945	-1780	-1695	-1945	-1780	-1695	mV
	VCC ≥ V <sub>CTRL</sub> > V <sub>BB</sub>		See Fig.2			See Fig.2			See Fig.2		
	V <sub>CTRL</sub> = V <sub>CC</sub> (Min Swing)	-1195	-1070	-945	-1205	-1080	-955	-1235	-1110	-985	
V <sub>IH</sub>	D, D Input HIGH Voltage (Single-Ended)	-1225		-880	-1225		-880	-1225		-880	mV
V <sub>IL</sub>	D, D Input LOW Voltage (Single-Ended)	-1945		-1625	-1945		-1625	-1945		-1625	mV
V <sub>BB</sub>	Output Voltage Reference	-1525	-1425	-1325	-1525	-1425	-1325	-1525	-1425	-1325	mV
V <sub>CTRL</sub>	Input Voltage (V <sub>CTRL</sub> )	V <sub>EE</sub>		V <sub>CC</sub>	V <sub>EE</sub>		V <sub>CC</sub>	V <sub>EE</sub>		V <sub>CC</sub>	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 11)	V <sub>EE</sub>	+2.0	-0.4	V <sub>EE</sub>	+2.0	-0.4	V <sub>EE</sub>	+2.0	-0.4	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current DDD	0.5 -150			0.5 -150			0.5 -150			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 10. All loading with 50 Ω to V<sub>CC</sub> 2.0 V. V<sub>OH</sub> does not change with V<sub>CTRL</sub>. V<sub>OL</sub> changes with V<sub>CTRL</sub>. V<sub>CTRL</sub> is referenced to V<sub>CC</sub>.
- 11. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

Table 7. AC CHARACTERISTICS V<sub>CC</sub> = 0 V; V<sub>EE</sub> = -3.0 V to -5.5 V or V<sub>CC</sub> = 3.0 V to 5.5 V; V<sub>EE</sub> = 0 V (Note 12)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Toggle Frequency (See Figure 6. F <sub>max</sub> /JITTER)		> 4			> 4			> 4		GHz
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay to Output Differential Max Swing Min Swing	150 90	220 150	280 210	150 90	220 150	280 210	160 100	240 160	300 220	ps
t <sub>SKEW</sub>	Duty Cycle Skew (Note 13)		5.0	20		5.0	20		5.0	20	ps
<sup>t</sup> JITTER	Cycle-to-Cycle Jitter (See Figure 6. F <sub>max</sub> /JITTER)		0.2	< 1		0.2	< 1		0.2	< 1	ps
V <sub>PP</sub>	Input Voltage Swing (Differential Configuration) (Note 14)	150	800	1200	150	800	1200	150	800	1200	mV
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times Max Swing Q (20% – 80%) Min Swing	70 30	120 80	170 130	80 20	130 70	180 120	100 20	150 70	200 120	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

<sup>9.</sup> Input and output parameters vary 1:1 with  $V_{CC}$ .

<sup>12.</sup> Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50  $\Omega$  to  $V_{CC}$  – 2.0 V.

<sup>13.</sup> Skew is measured between outputs under identical transitions. Duty cycle skew is defined only for differential operation when the delays are measured from the cross point of the inputs to the cross point of the outputs.

<sup>14.</sup> V<sub>PP</sub>(min) is minimum input swing for which AC parameters are guaranteed.

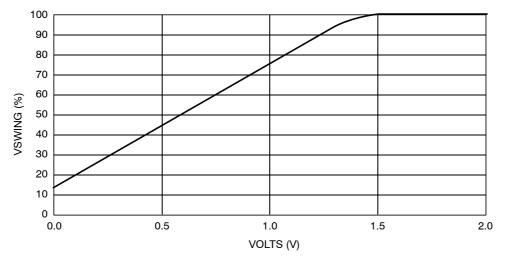


Figure 2.  $V_{CC}$  –  $V_{CTRL}$  (pin #1)

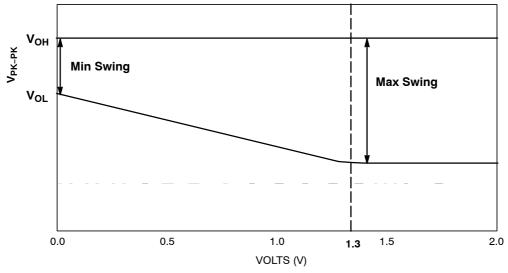


Figure 3. V<sub>CC</sub> - V<sub>CTRL</sub>

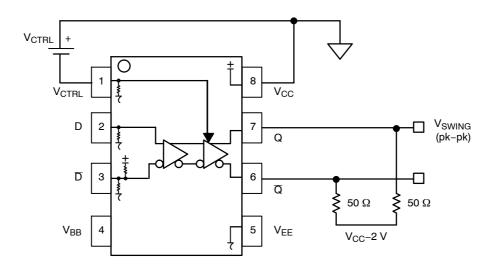


Figure 4. Voltage Source Implementation

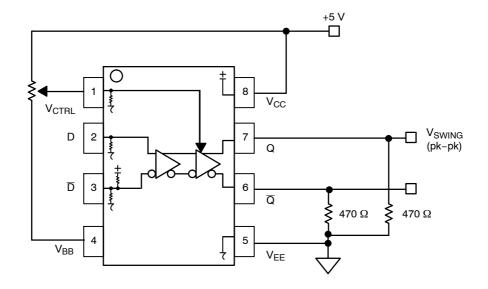


Figure 5. Alternative Implementation

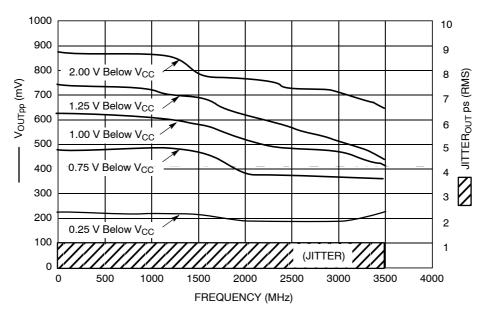


Figure 6. F<sub>max</sub>/Jitter

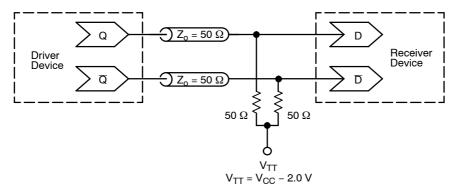


Figure 7. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC100EP16VSD	SOIC-8	98 Units / Rail
MC100EP16VSDG	SOIC-8 (Pb-Free)	98 Units / Rail
MC100EP16VSDR2	SOIC-8	2500 / Tape & Reel
MC100EP16VSDR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel
MC3100EP16VSDT	TSSOP-8	100 Units / Rail
MC3100EP16VSDTG	TSSOP-8 (Pb-Free)	100 Units / Rail
MC100EP16VSDTR2	TSSOP-8	2500 / Tape & Reel
MC100EP16VSDTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel
MC100EP16VSMNR4	DFN8	1000 / Tape & Reel
MC100EP16VSMNR4G	DFN8 (Pb-Free)	1000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### **Resource Reference of Application Notes**

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

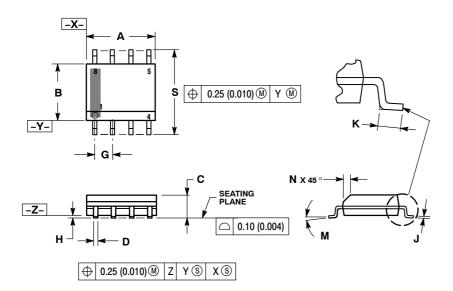
AND8020/D - Termination of ECL Logic Devices

AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

### PACKAGE DIMENSIONS

### SOIC-8 NB CASE 751-07 **ISSUE AH**



### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.

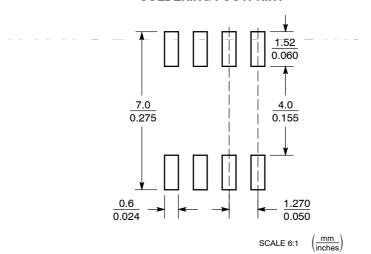
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- PER SIDE.
- PER SIDE.

  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

  6. 751–01 THRU 751–06 ARE OBSOLETE. NEW CTANIDAD 18 751–07
- STANDARD IS 751-07.

	MILLIN	IETERS	INC	HES			
DIM	MIN	MAX	MIN	MAX			
Α	4.80	5.00	0.189	0.197			
В	3.80	4.00	0.150	0.157			
С	1.35	1.75	0.053	0.069			
D	0.33	0.51	0.013	0.020			
G	1.27	7 BSC	0.05	0 BSC			
Н	0.10	0.25	0.004	0.010			
J	0.19	0.25	0.007	0.010			
K	0.40	1.27	0.016	0.050			
M	0 °	8 °	0 °	8 °			
N	0.25	0.50	0.010	0.020			
S	5.80	6.20	0.228	0 244			

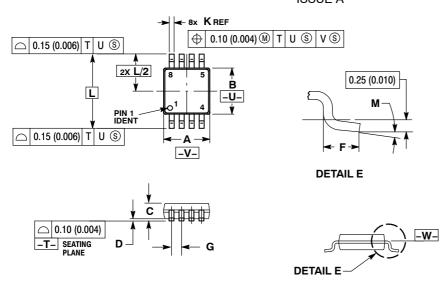
### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### **PACKAGE DIMENSIONS**

### TSSOP-8 **DT SUFFIX** PLASTIC TSSOP PACKAGE CASE 948R-02 **ISSUE A**



### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- Y14.5M, 1982.

  CONTROLLING DIMENSION: MILLIMETER.

  DIMENSION A DOES NOT INCLUDE MOLD FLASH.
  PROTRUSIONS OR GATE BURRS. MOLD FLASH
  OR GATE BURRS SHALL NOT EXCEED 0.15
  (0.006) PER SIDE.

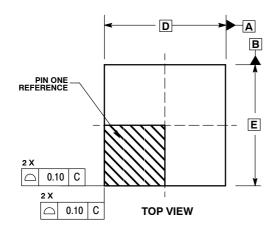
  DIMENSION B DOES NOT INCLUDE INTERLEAD
- FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PROTHUSION SHALL NOT EXCEED 0.25 (0.010)
  PER SIDE.

  5. TERMINAL NUMBERS ARE SHOWN FOR
  REFERENCE ONLY.
  6. DIMENSION A AND B ARE TO BE DETERMINED
  AT DATUM PLANE -W-.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	2.90	3.10	0.114	0.122	
В	2.90	3.10	0.114	0.122	
С	0.80	1.10	0.031	0.043	
D	0.05	0.15	0.002	0.006	
F	0.40	0.70	0.016	0.028	
G	0.65	BSC	0.026	BSC	
K	0.25	0.40	0.010	0.016	
L	4.90	BSC	0.193	BSC	
М	0°	6 °	0°	6°	

### PACKAGE DIMENSIONS

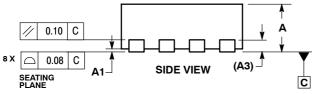
### DFN8 CASE 506AA-01 ISSUE D

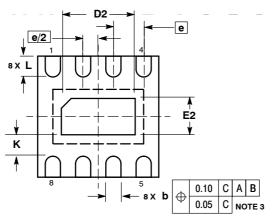


### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
  B. DIMENSION & APPLIES TO PLATED
- 3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
- 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS					
DIM	MIN	MAX				
Α	0.80	1.00				
A1	0.00	0.05				
А3	0.20	REF				
b	0.20	0.30				
D	2.00	BSC				
D2	1.10	1.30				
E	2.00	BSC				
E2	0.70	0.90				
e	0.50	BSC				
K	0.20					
L	0.25	0.35				





### **BOTTOM VIEW**

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